

The reducing atmosphere of the Spark Plasma Sintering: a disadvantage or an advantage for oxides?

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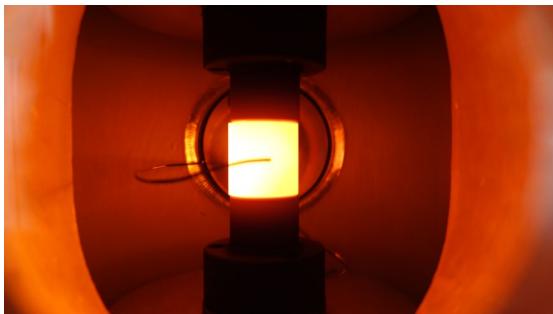
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Summary

- 1- Piezoelectric material : $K_{0.5}Na_{0.5}NbO_3$ (KNN)
- 2- Thermoelectric oxide : $Sr_{0.95}La_{0.05}TiO_3$.
- 3- Thermoelectric oxide : $La_{0.66}Ti_{0.95}Al_{0.05}O_3$
- 4- Ionic conductor: $La_2Mo_2O_9$

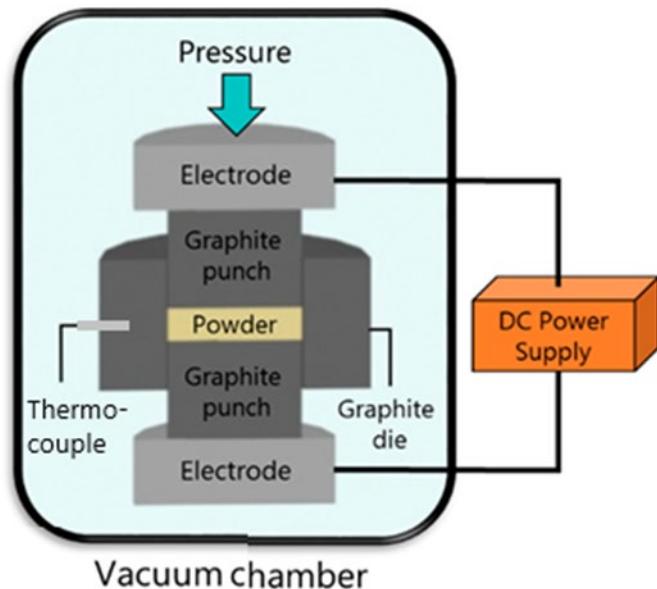
Spark plasma sintering – a way for high relative densities



SPS 632Lx –Fuji Electronics
3000 A – 60 kN

Benefits:

- Lower temperature – shorter time
- Prevent alkali volatilization
- High relative densities

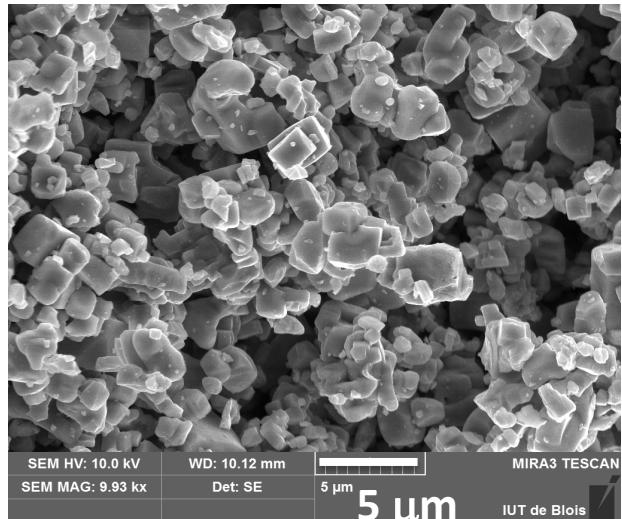


Drawbacks ?

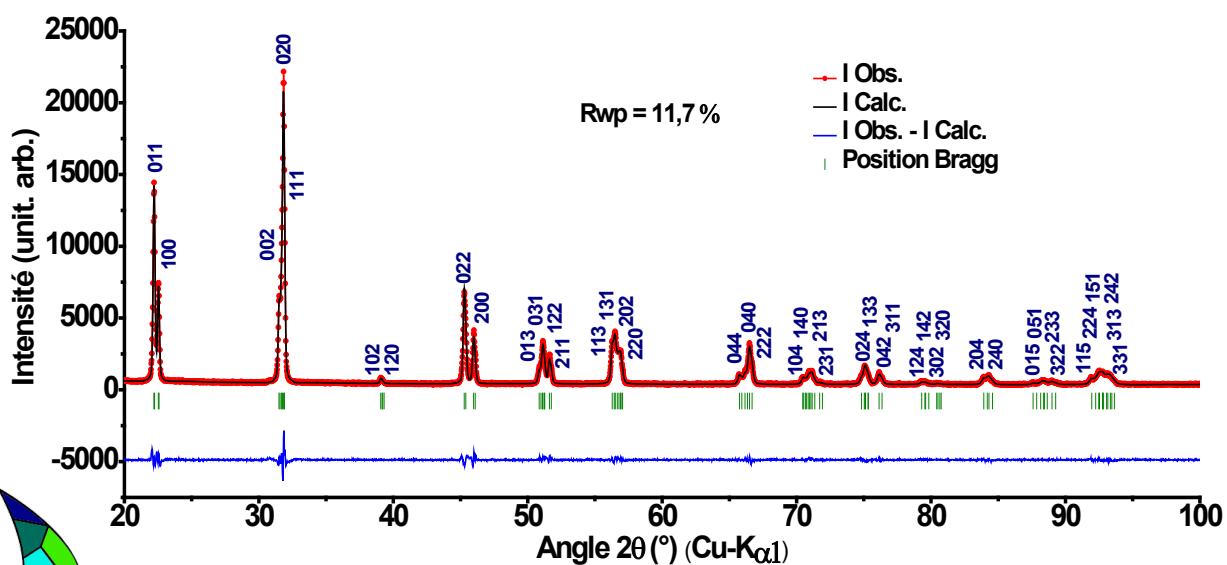
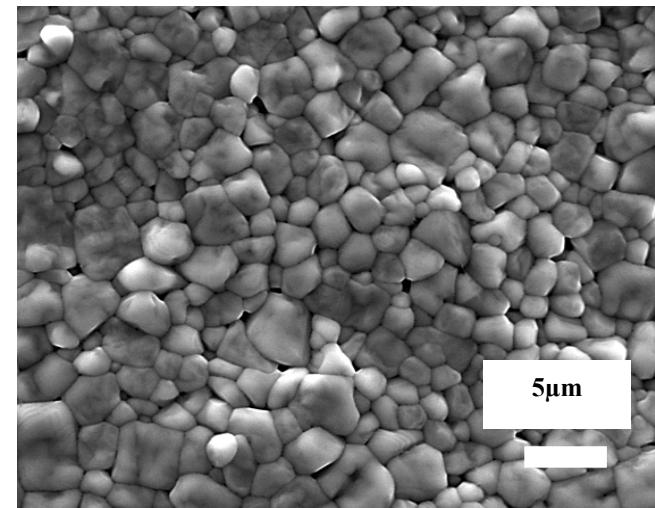
- C contamination with graphite materials ?
- Reductive conditions / oxygen losses ?
- Densification mechanisms: creep/ defects ?

Impact of SPS on piezoelectric material : $K_{0.5}Na_{0.5}NbO_3$ (KNN)

KNN, $K_{0.5}Na_{0.5}NbO_3$

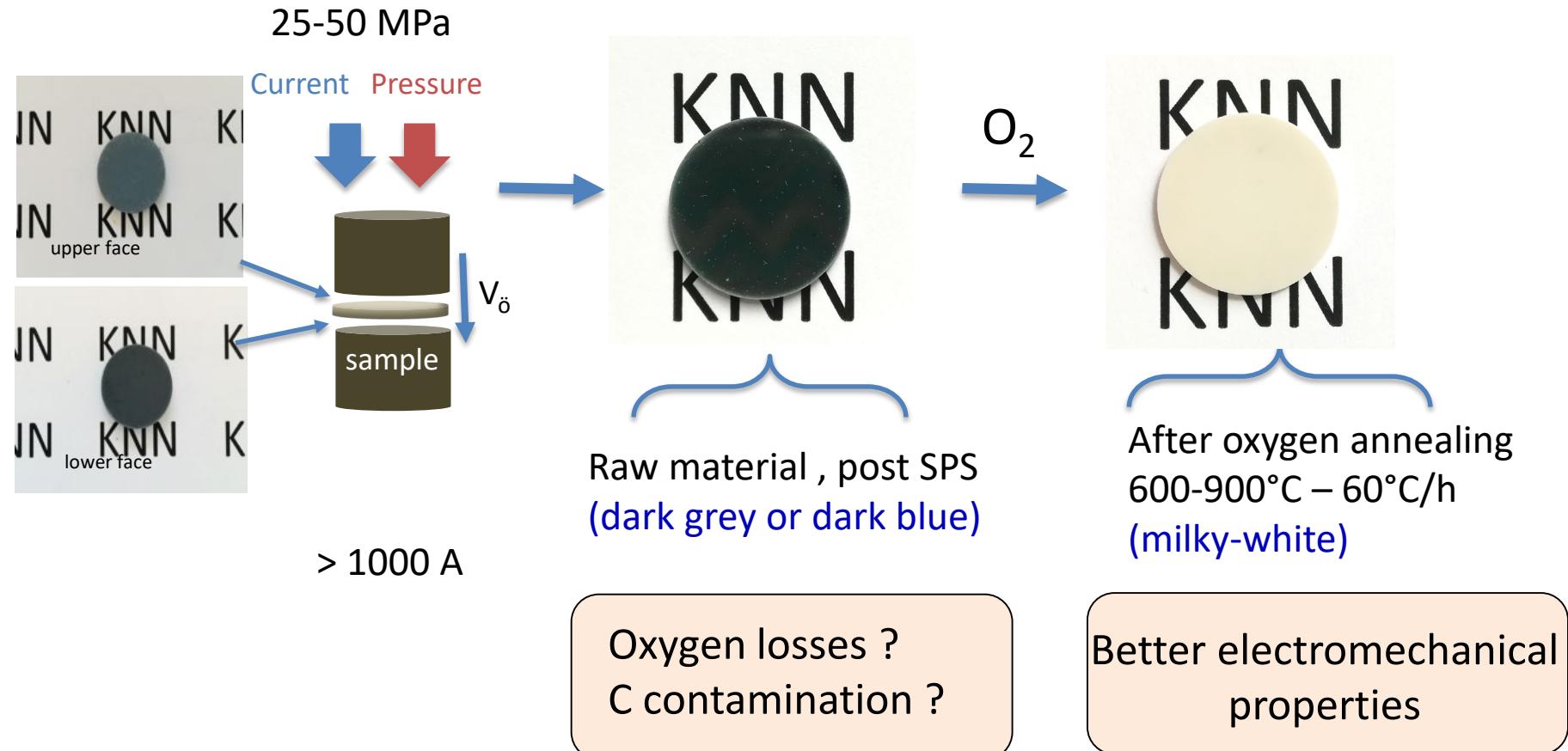


SPS - 920°C - 98% - 3μm

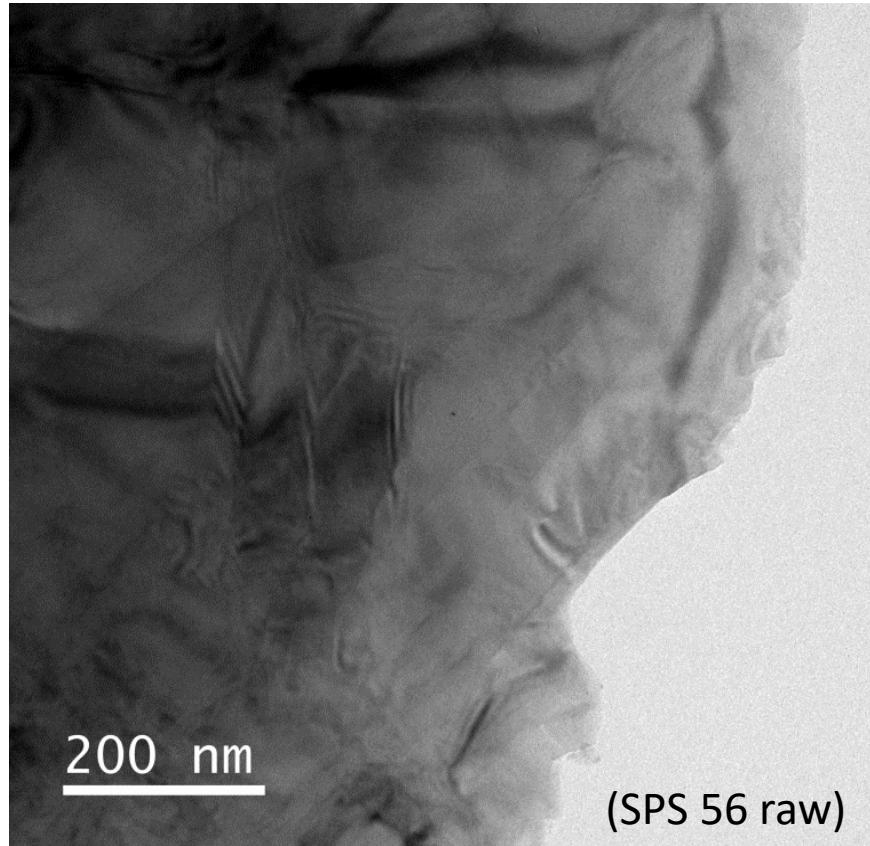


Orthorhombic, $Amm2$
 $a = 3.945 \text{ \AA}$
 $b = 5.646 \text{ \AA}$
 $c = 5.678 \text{ \AA}$

What about drawbacks ?

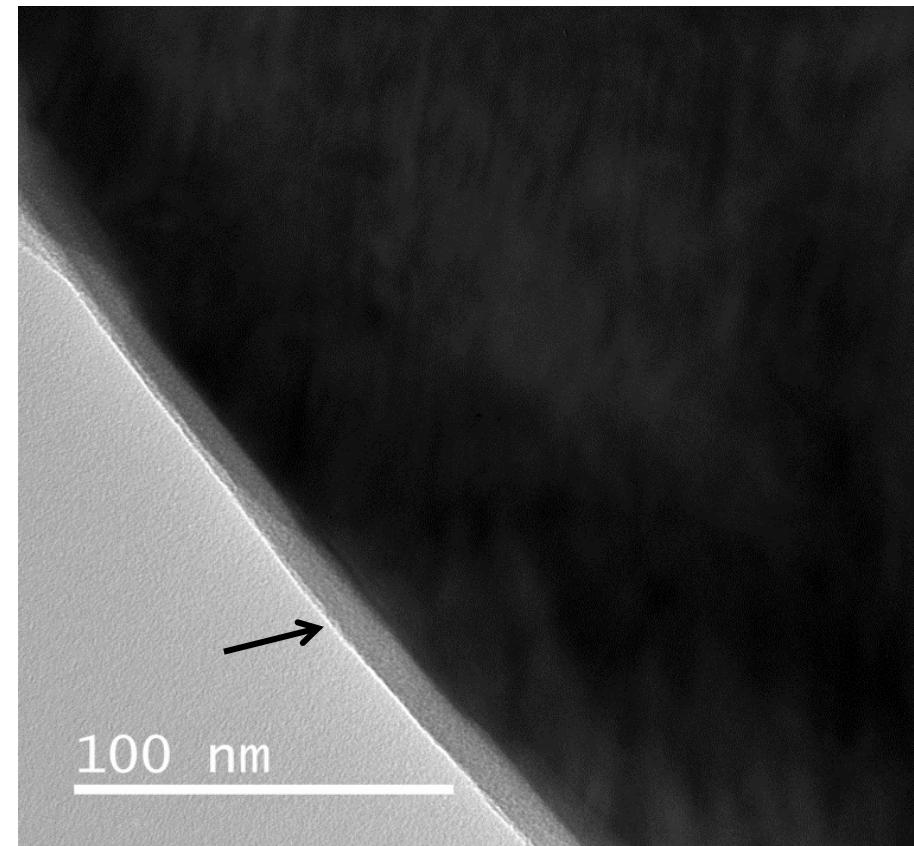


Defects in raw KNN SPS sintered



disturbed contrasts
→ stresses
→ crystallites' defects

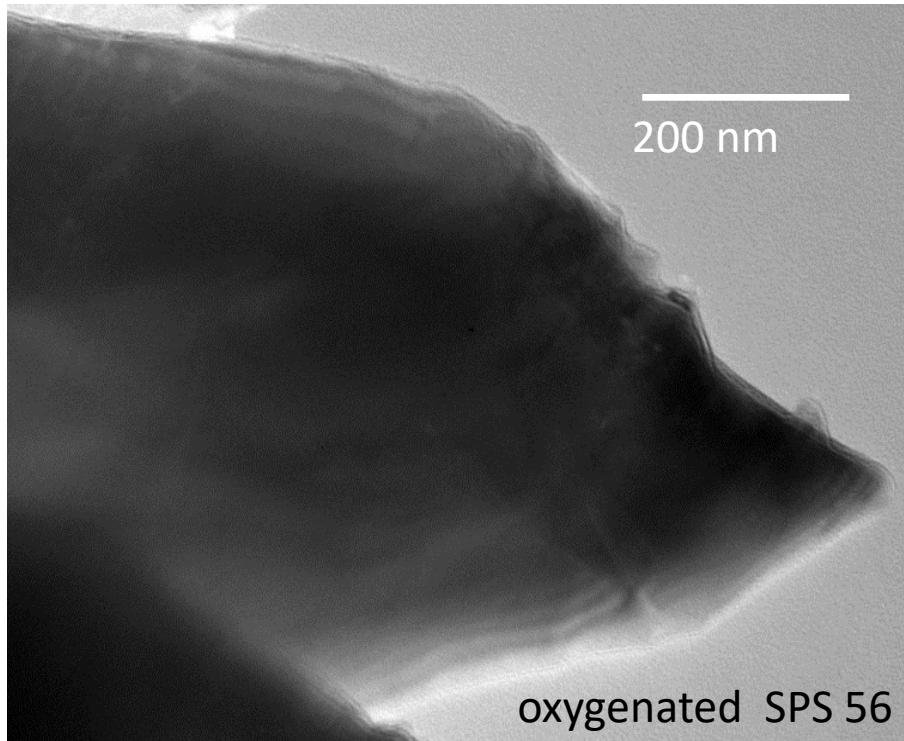
a



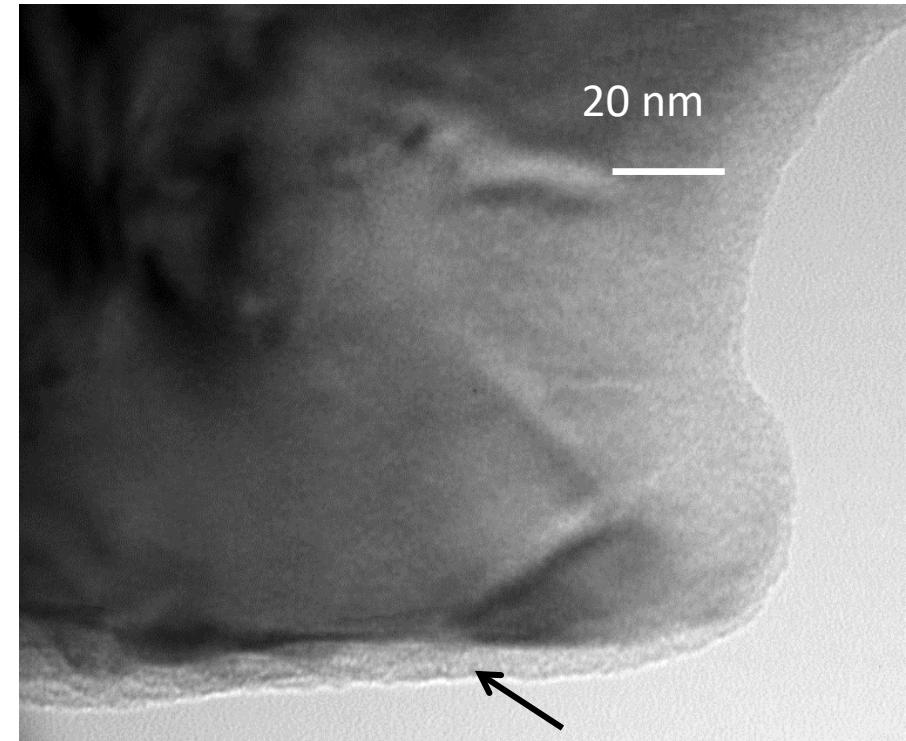
b
Systematically,
amorphous carbon strips (few nm)
around the grains.

KNN
KNN

After oxygen annealing



a



b

Regular and homogeneous
contrasts → low stress
→ Low defects.

No more C on grains' edge

OXYGEN ANNEALING suppresses C contamination, stresses and defects



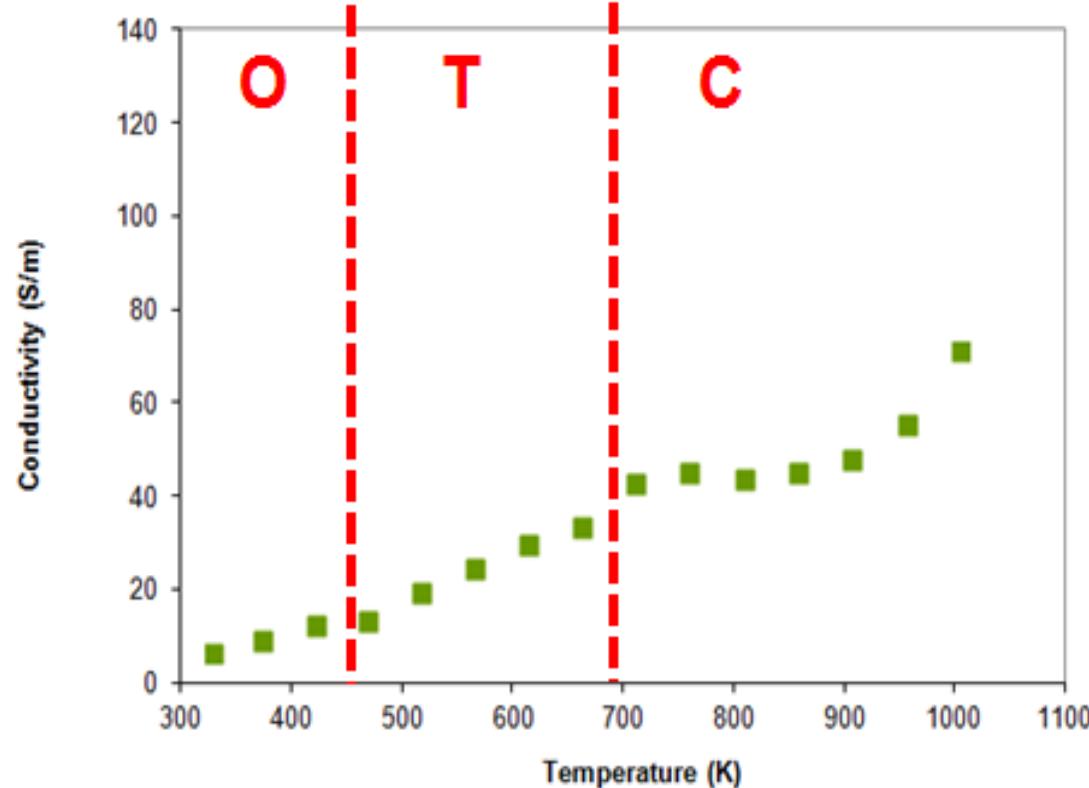
raw SPS-KNN : Electrical conduction

Charge carriers



Oxygen vacancies

Oxygen annealing



NO MORE
conductivity

Easy to recover oxygen content

Impact of SPS on thermoelectric oxide :

$Sr_{0.95}La_{0.05}TiO_3$

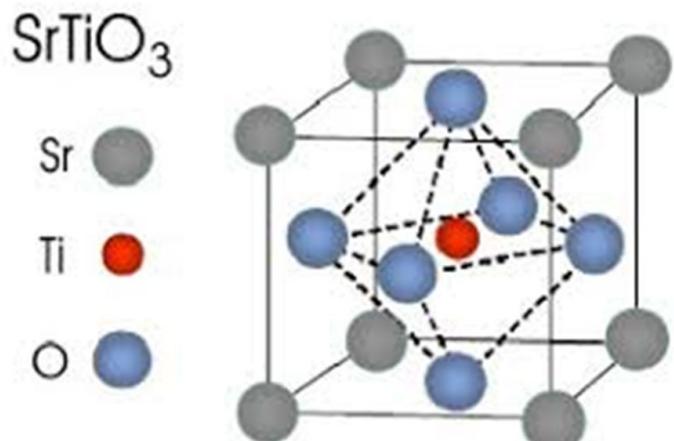
$$ZT = T S^2 \sigma / \kappa = T P F / \kappa$$

S = Seebeck coefficient ($\mu\text{V/K}$)

σ = Electrical conductivity (S.m^{-1})

κ = Thermal conductivity ($\text{W.m}^{-1}\text{.K}^{-1}$)

PF = Power factor ($\text{W.K}^{-2}\text{.m}^{-1}$)



- Perovskite structure

- N-type Semiconductor with a band gap of 3,2 eV

- La substitution = High Power factor : $2 \cdot 10^{-3} \text{ W/m K}^2$
Okuda et al. Physical Review B 63 (2001) 113104.

- High thermal conductivity : $7 - 4 \text{ W/m K}$

Muta et al. Journal of alloys and compounds 350 (2003) 292?



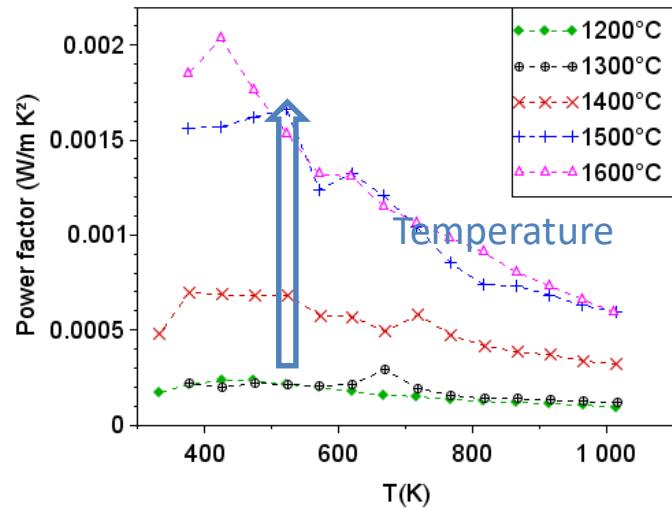
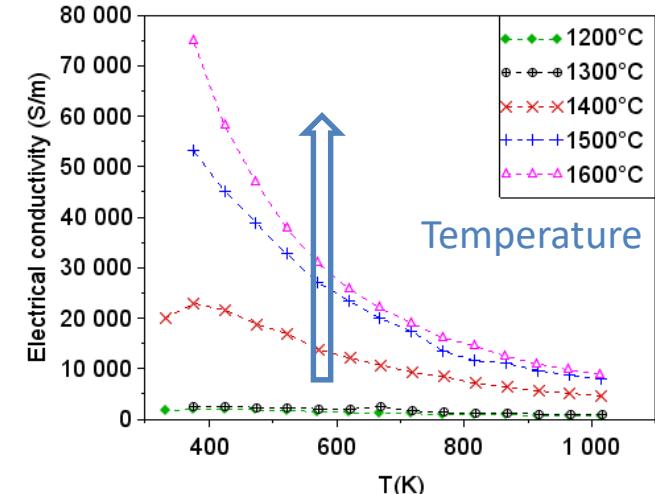
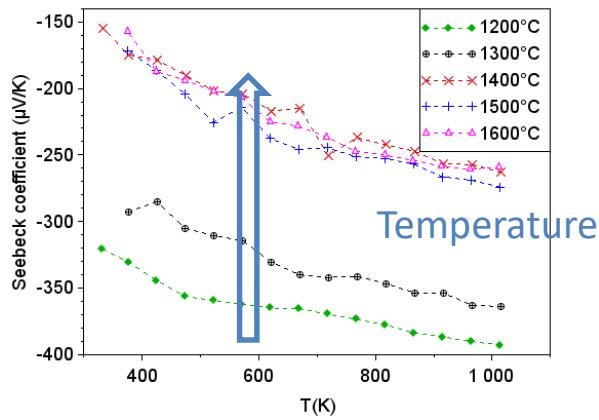
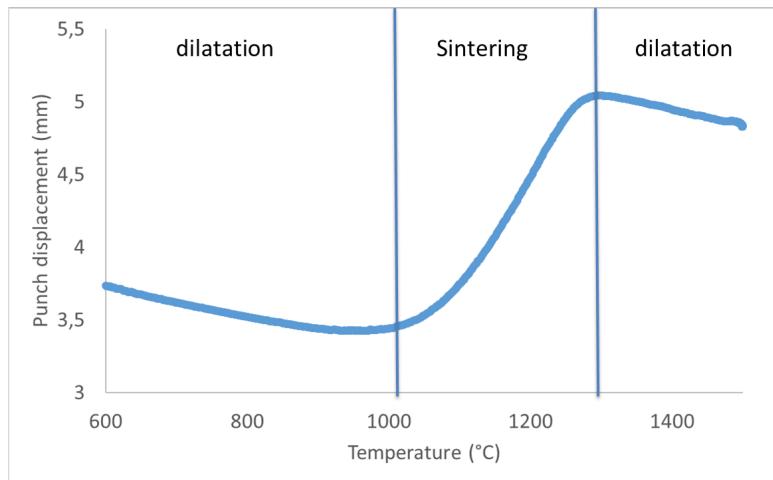
Optimized properties require sintering under Ar/H_2 or long term annealing at 1400°C under Ar/H_2 after sintering



SPS

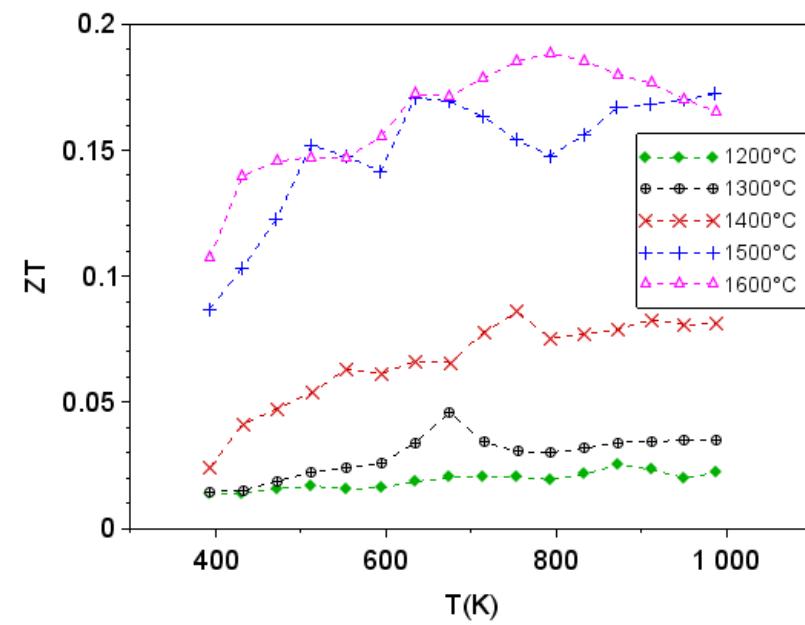
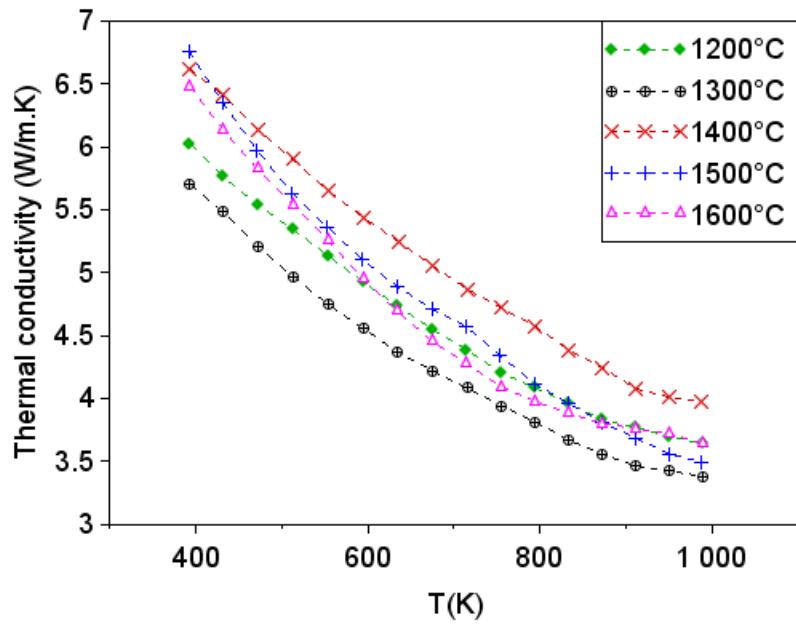
SPS Conditions

80 MPa
10 min



with increasing sintering temperature

- Electrical conductivity increases
- Seebeck coefficient value decreases with sintering temperature
- PF of 2 mW/m K² is reached at 100°C with a sintering temperature of 1600°C

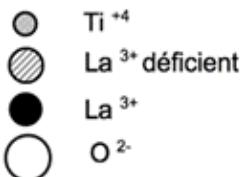
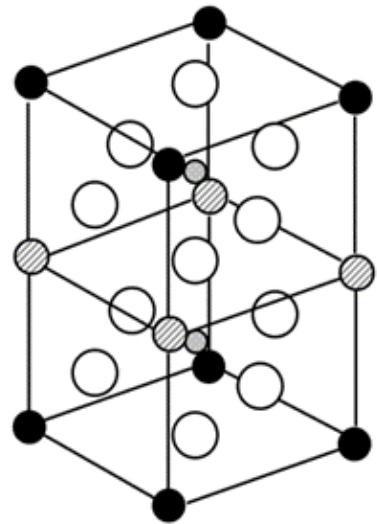


- Thermal conductivity evolution does not show clear trend
- ZT reaches 0.15 @ 400K and 0.19 @ 800K
- No more post annealing under Ar/H₂
- Fast process (few minutes versus several hours)

Impact of SPS on thermoelectric oxide :



$\text{La}_{0.66}\text{TiO}_3$

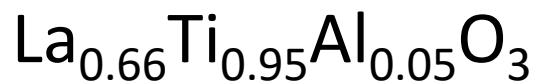


A-deficient perovskite

c parameter doubling

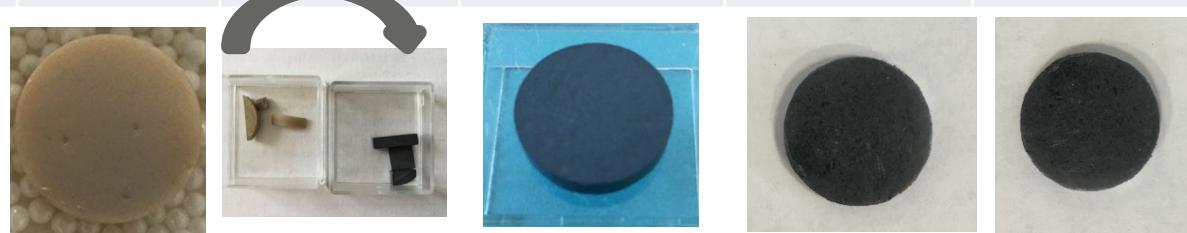
Stabilization with Al

Abe et al (1974) Mat. Res. Bull. 1974

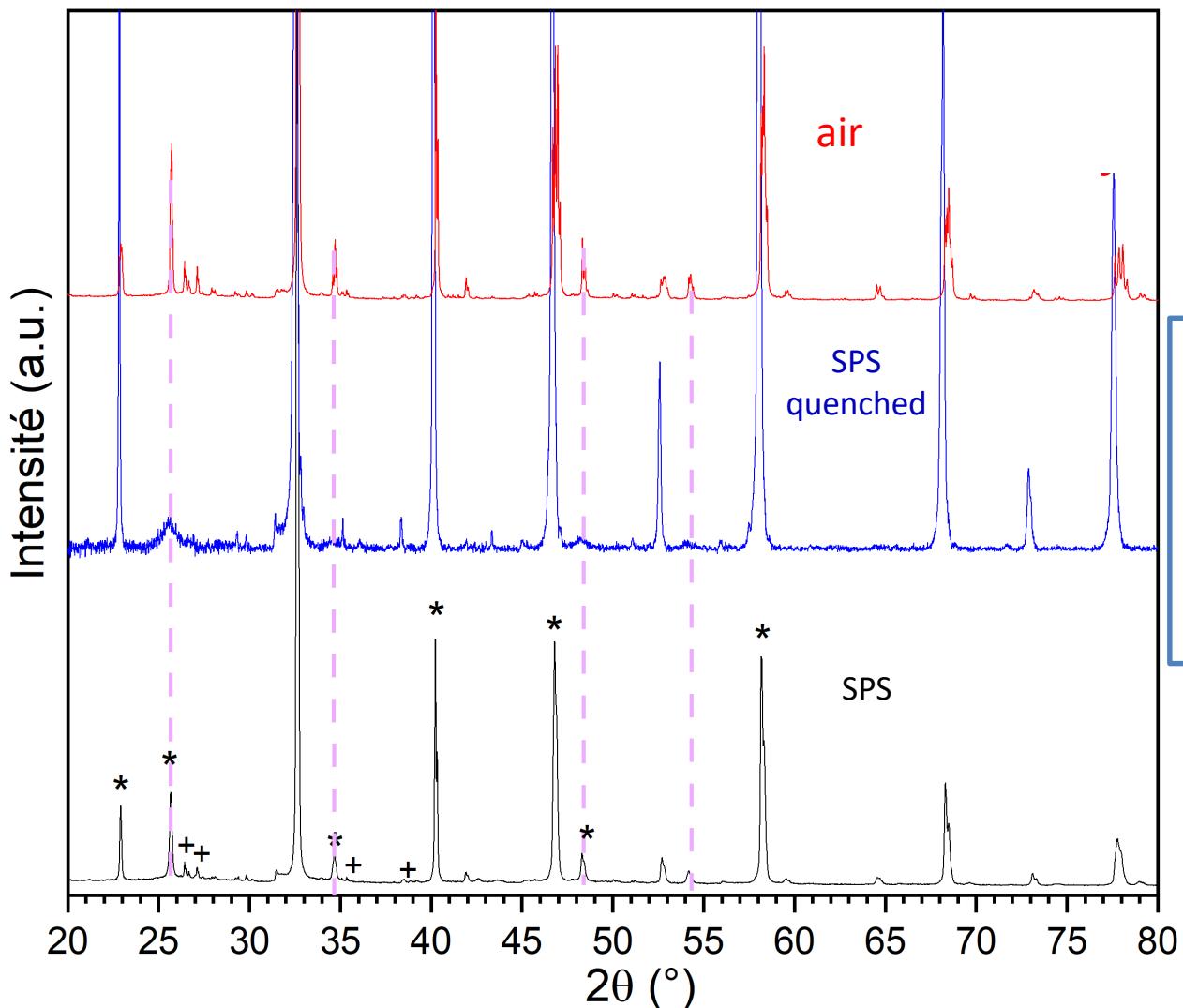


Thermal conductivity decreases

	air	air + annealing	Ar/H ₂	SPS	SPS quenched
Sintering temperature	1400°C	1400°C	1400°C	1300°C	1300°C
Time	8 h	8 h	8 h	5 min	0
Time and temperature of Ar/H ₂ annealing		76 h 1300°C			
Density	90%	90 %	92 %	98%	98%



* $\text{La}_{0.68}\text{Ti}_{0.95}\text{Al}_{0.05}\text{O}_3$ (04-013-6845) + $\text{La}_4\text{Ti}_9\text{O}_{24}$ (04-013-3201)



- Expected phase
- Impurities
- Quenched = low intensity of surstructure peaks

Rietveld fit of SPS Quenched

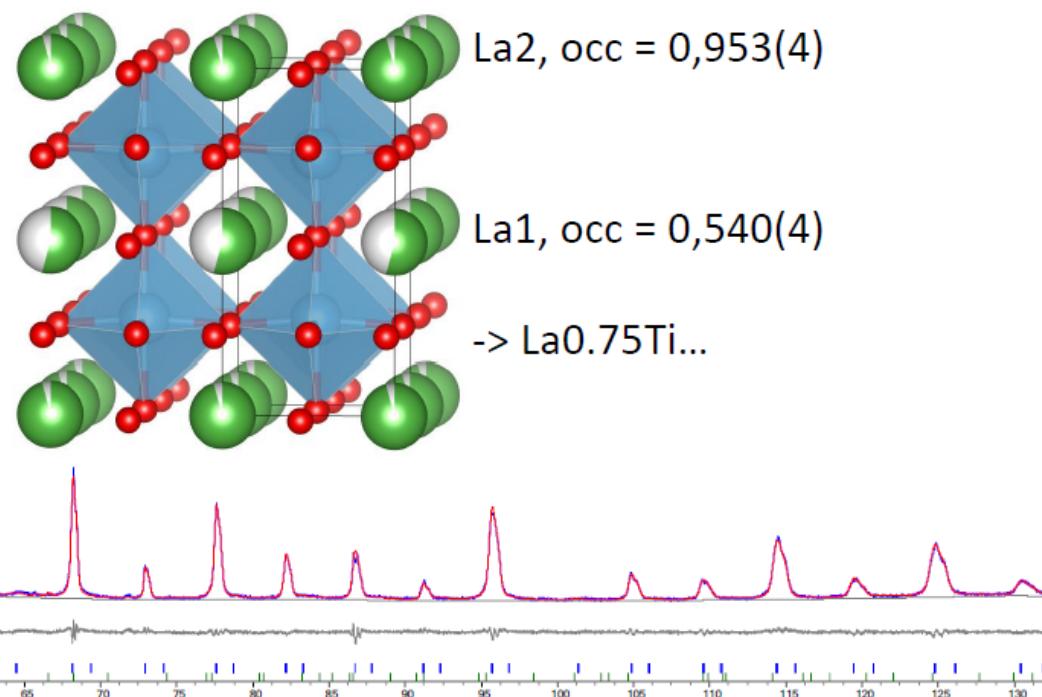
Pmmm

$$a = 3,888(2) \text{ \AA}$$

$$b = 3,888(2) \text{ \AA}$$

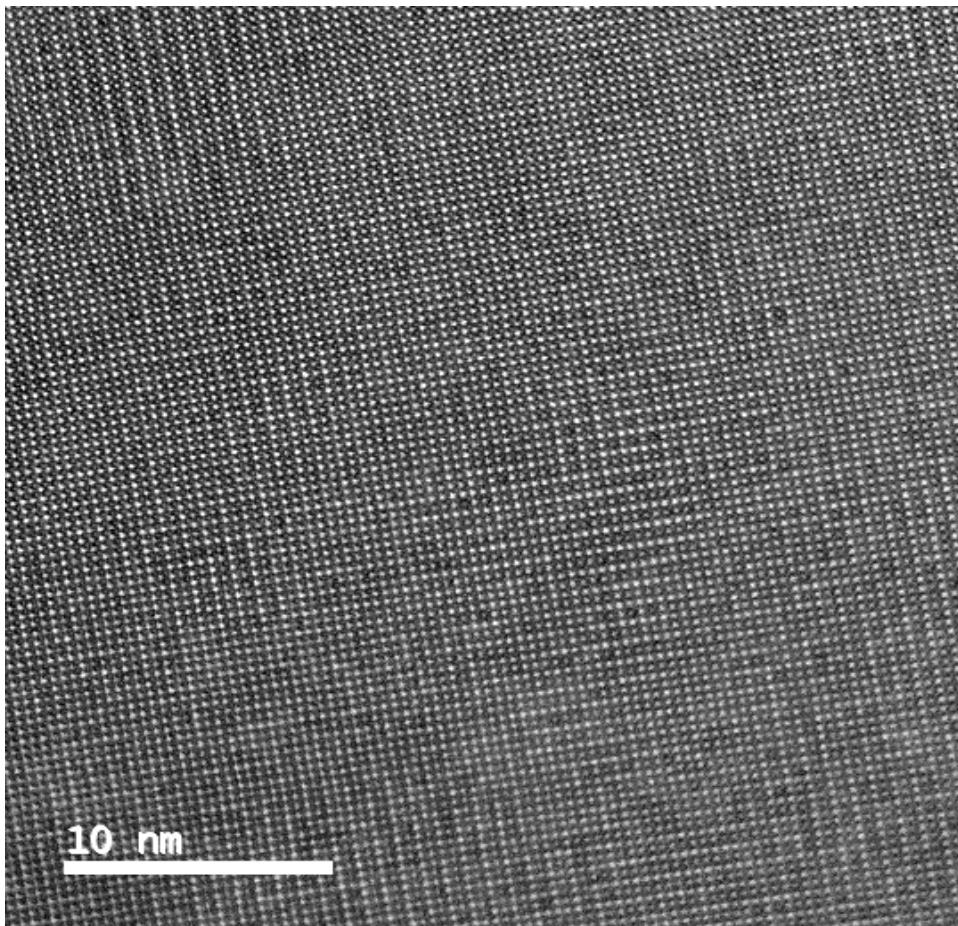
$$c = 7,778(2) \text{ \AA}$$

La, Ti parameters refined freely
O parameters fixed to published values

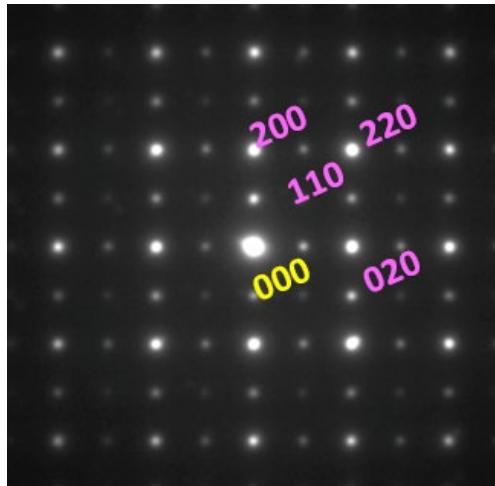


Pmmm is still good enough to produce a good Rietveld fit with reliable refined occupancies

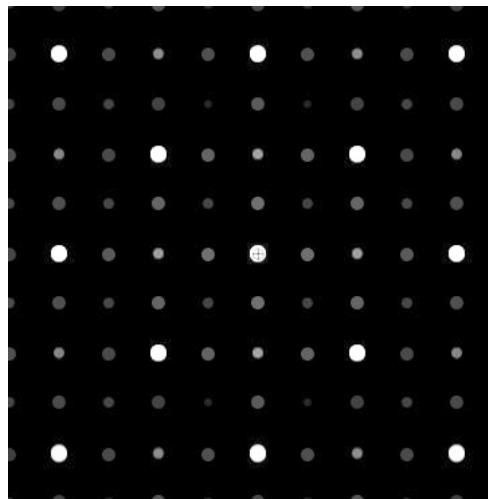
- The sample is fully-ordered at the unit-cell level
- The ordered domains have a size distribution centred around 6 nm



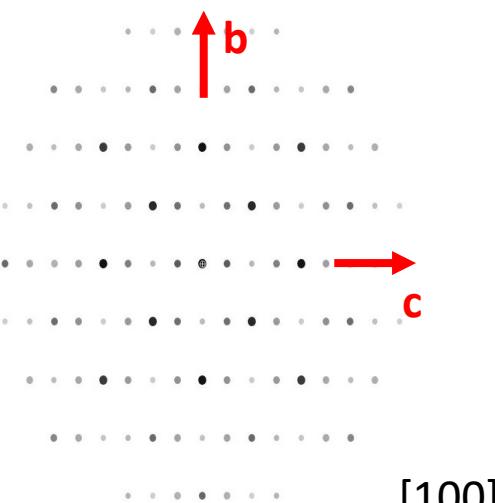
STEM-HAADF image at the atomic resolution of the quenched sample prepared as a thin lamella.



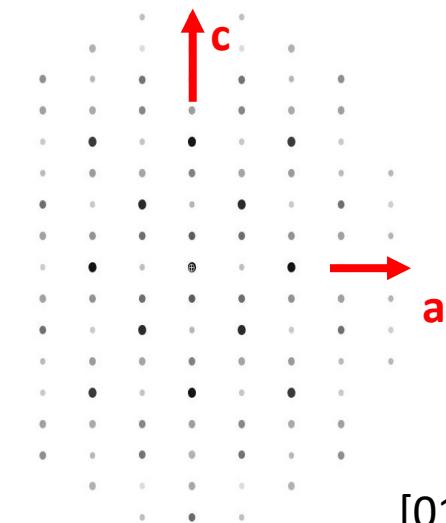
Selected Area Electron Diffraction pattern obtained, along the [100] zone axis family ([100], [010], [001]).



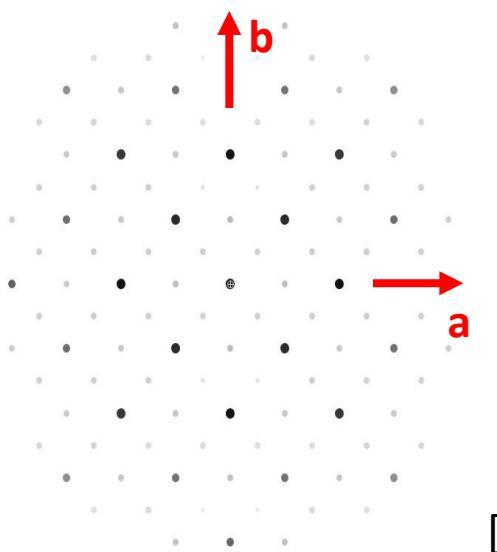
By superposition of the 3 simulated electron diffraction patterns we can reproduce an electron diffraction pattern with a very good match with the experimental SAED.



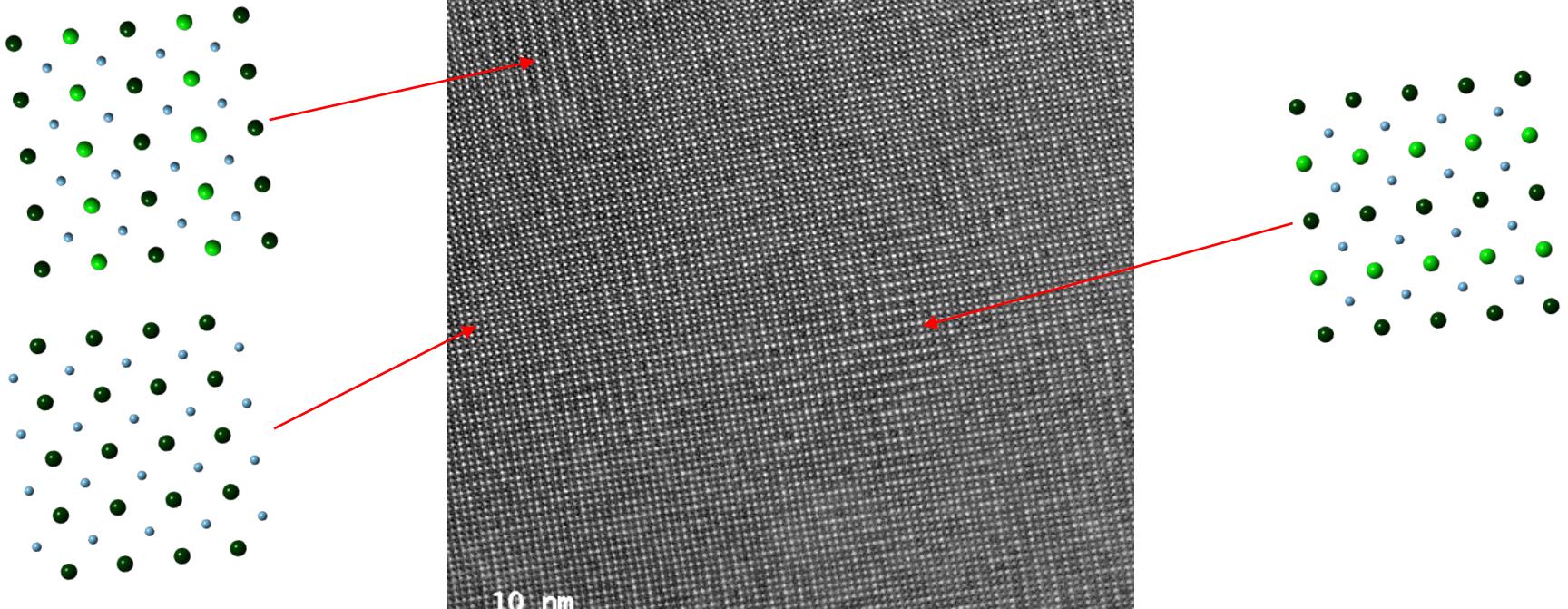
[100]



[010]



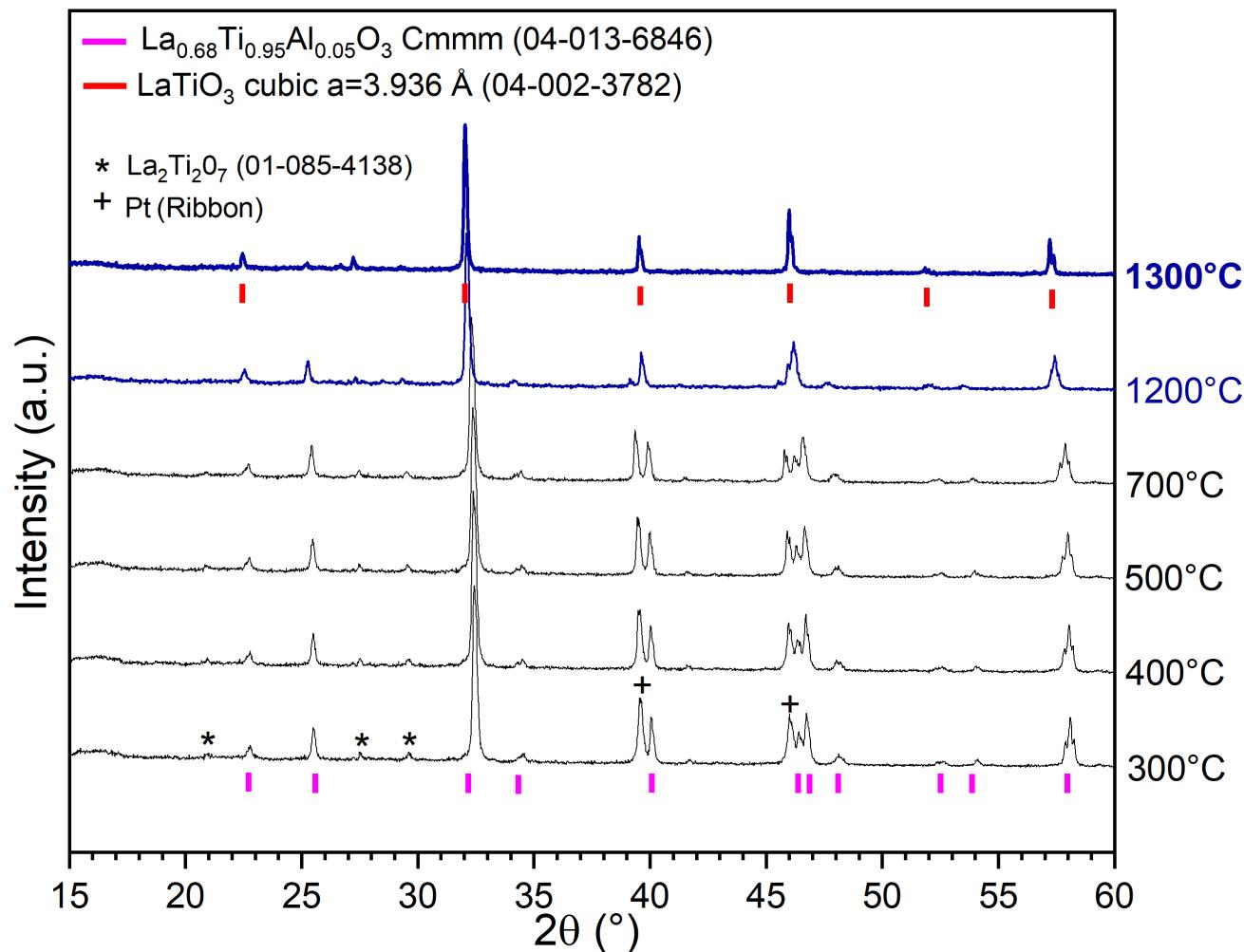
[001]



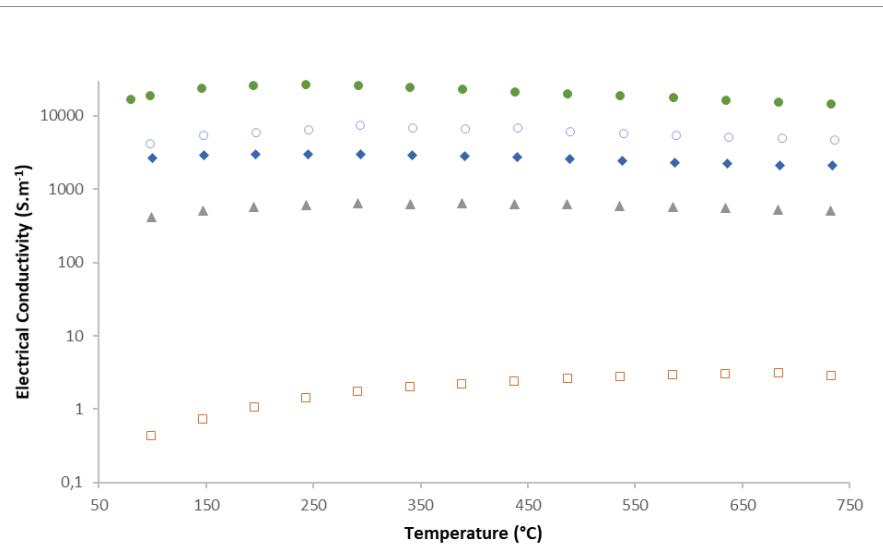
STEM-HAADF image at the atomic resolution of the quenched sample.



Presence of nanodomains



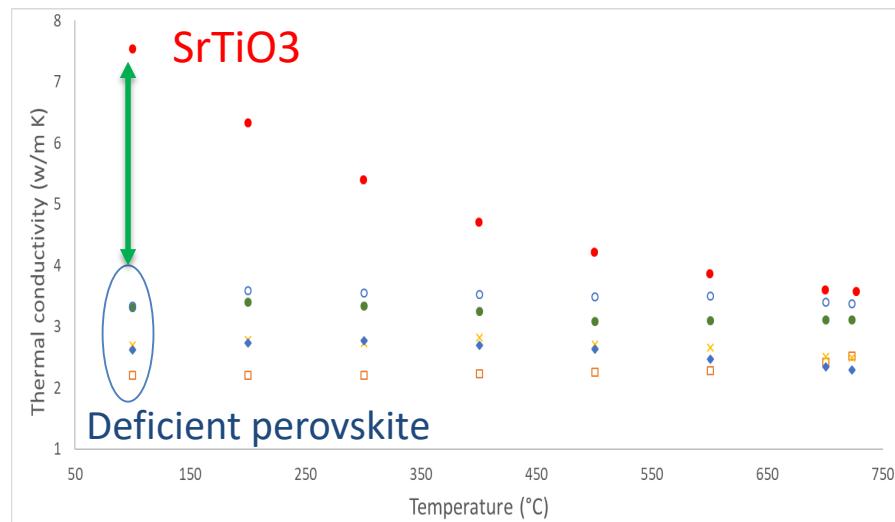
High temperature cubic phase



SPS-quenched
SPS
Sintering Ar/H₂
Annealing Ar/H₂

air

Best PF is obtained for the quenched sample



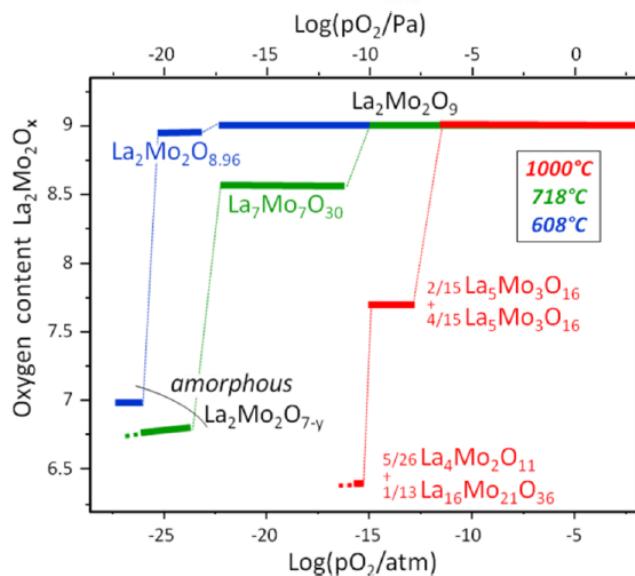
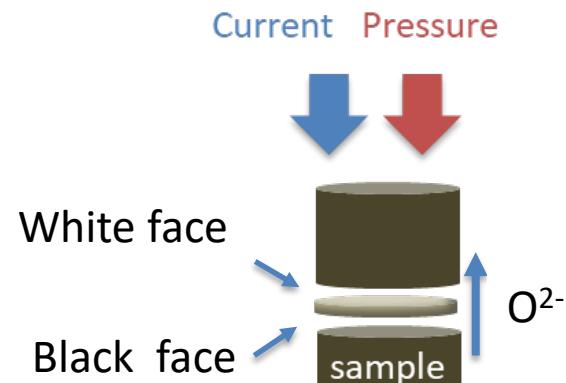
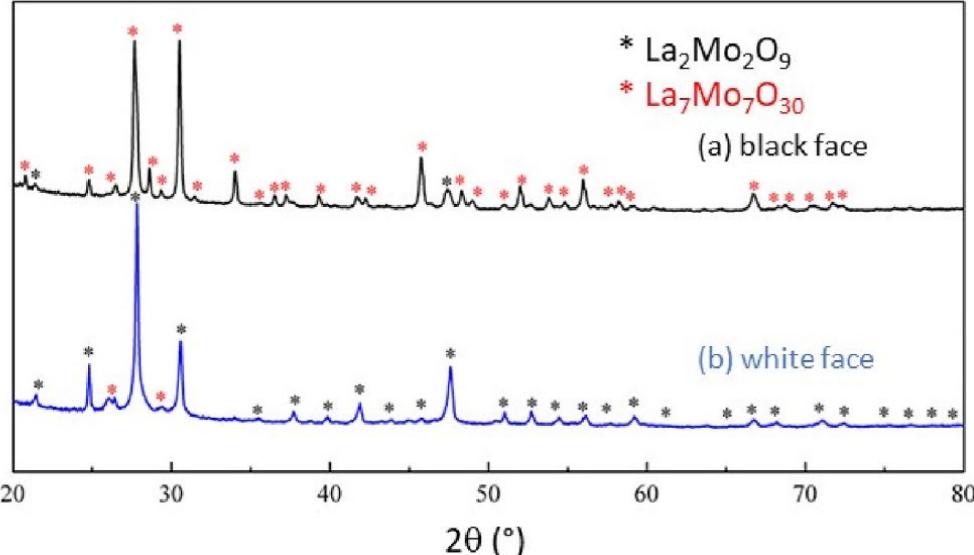
The thermal conductivity is divided by 2 at 100°C in comparison of SrTiO₃

ZT of 0.12 is reached at 1000K

Impact of SPS on Ionic conductor : $\text{La}_2\text{Mo}_2\text{O}_9$

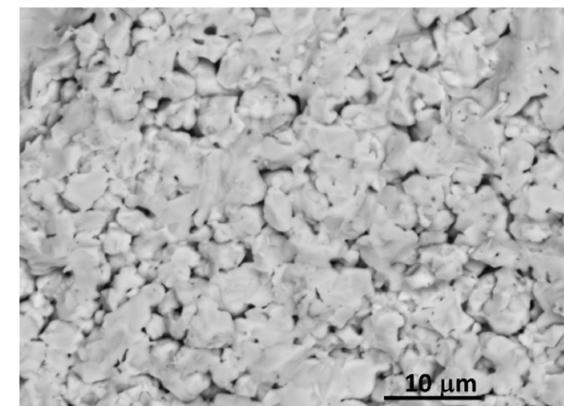
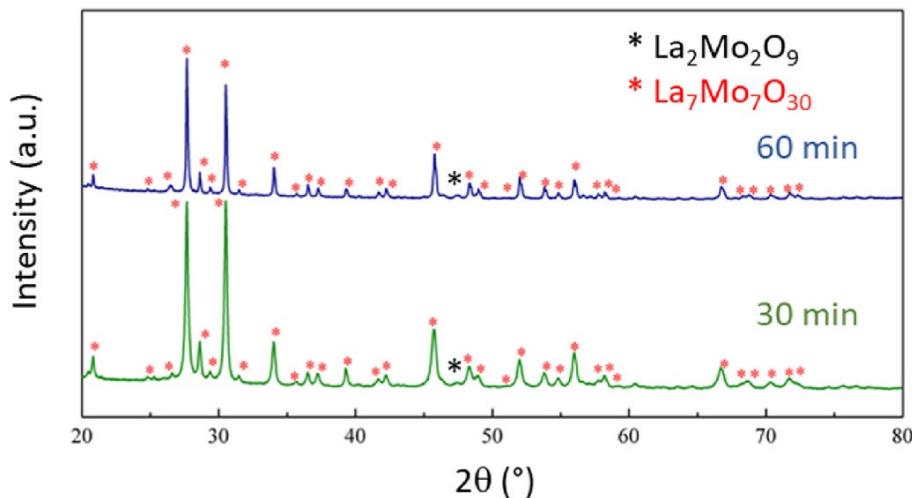
SPS 700°C , 5 min, 90 MPa

Intensity (a.u.)

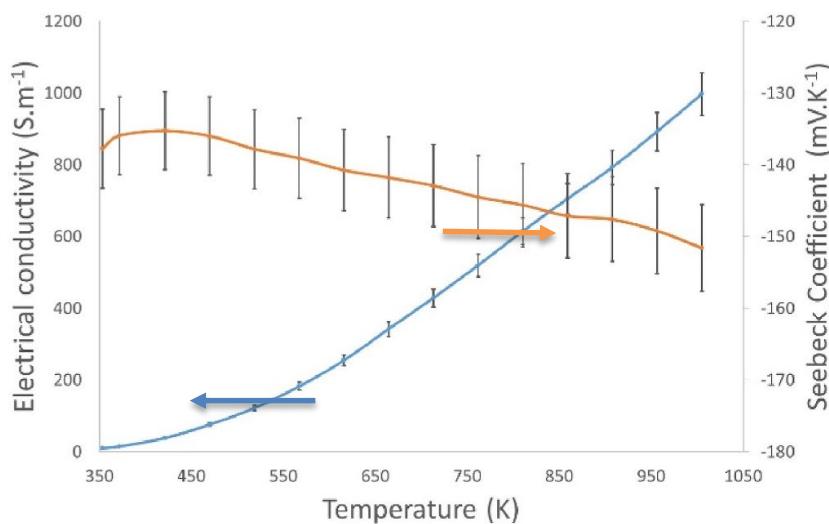


$\text{La}_2\text{Mo}_2\text{O}_9$ in situ transformation in reduced phase $\text{La}_7\text{Mo}_7\text{O}_{30}$

SPS 700°C , 90 MPa



89 % relative density



Thermoelectric properties evaluation of
the reduced phase $\text{La}_7\text{Mo}_7\text{O}_{30}$
 $ZT = 0,04 @ 1000K$

Conclusion

- Oxygen annealing allows recovering piezoelectric material in KNN
- Reducing atmosphere leads to good thermoelctric properties without Ar/H₂ annealing
- Quenched La_{0,66}Ti_{0,95}Al_{0,05}O₃ sample exhibits nanodomains
- In situ transformation of La₂Mo₂O₉
- Obtention of La₇Mo₇O₃₀ ceramic

SPS could be advantage or disadvantage depending on what we are looking for but obviously new opportunities